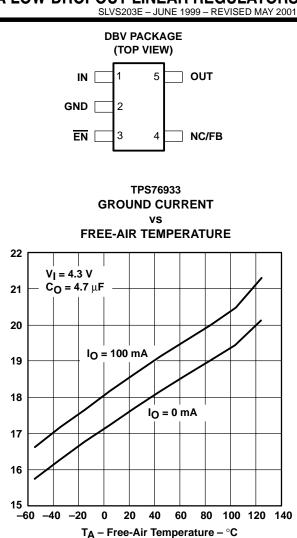
- 100-mA Low-Dropout Regulator
- Available in 1.2-V, 1.5-V, 1.8-V, 2.5-V, 2.7-V, 2.8-V, 3.0-V, 3.3-V, and 5-V Fixed-Output and Adjustable Versions
- Only 17 μA Quiescent Current at 100 mA
- 1 µA Quiescent Current in Standby Mode
- Dropout Voltage Typically 71 mV at 100mA
- Over Current Limitation
- -40°C to 125°C Operating Junction Temperature Range
- 5-Pin SOT-23 (DBV) Package

description

The TPS769xx family of low-dropout (LDO) voltage regulators offers the benefits of low dropout voltage, ultralow-power operation, and miniaturized packaging. These regulators feature low dropout voltages and ultralow quiescent current compared to conventional LDO regulators. Offered in a 5-terminal small outline integrated-circuit SOT-23 package. the TPS769xx series devices are ideal for micropower operations and where board space is at a premium.

A combination of new circuit design and process innovation has enabled the usual PNP pass transistor to be replaced by a PMOS pass element. Because the PMOS pass element behaves as a low-value resistor, the dropout voltage is very low, typically 71 mV at 100 mA of



load current (TPS76950), and is directly proportional to the load current. Since the PMOS pass element is a voltage-driven device, the quiescent current is ultralow (28 μ A maximum) and is stable over the entire range of output load current (0 mA to 100 mA). Intended for use in portable systems such as laptops and cellular phones, the ultralow-dropout voltage feature and ultralow-power operation result in a significant increase in system battery operating life.

Ground Current – μ A

The TPS769xx also features a logic-enabled sleep mode to shut down the regulator, reducing quiescent current to 1 μ A typical at T_J = 25°C. The TPS769xx is offered in 1.2-V, 1.5-V, 1.8-V, 2.5-V, 2.7-V, 2.8-V, 3.0-V, 3.3-V, and 5-V fixed-voltage versions and in a variable version (programmable over the range of 1.2 V to 5.5 V).



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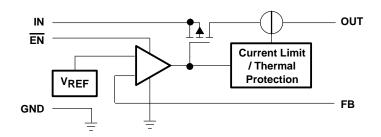
		AVAILAE	BLE OPTIONS		
ТJ	VOLTAGE	PACKAGE	PART N	UMBER	SYMBOL
	Variable 1.2V to 5.5V		TPS76901DBVT [†]	TPS76901DBVR [‡]	PCFI
	1.2 V		TPS76912DBVT [†]	TPS76912DBVR [‡]	PCGI
	1.5 V	SOT-23 (DBV)	TPS76915DBVT [†]	TPS76915DBVR [‡]	PCHI
	1.8 V		TPS76918DBVT [†]	TPS76918DBVR [‡]	PCII
-40°C to 125°C	2.5 V		TPS76925DBVT [†]	TPS76925DBVR [‡]	PCJI
	2.7 V		TPS76927DBVT [†]	TPS76927DBVR [‡]	PCKI
	2.8 V		TPS76928DBVT [†]	TPS76928DBVR [‡]	PCLI
	3.0 V		TPS76930DBVT [†]	TPS76930DBVR [‡]	PCMI
	3.3 V		TPS76933DBVT [†]	TPS76933DBVR [‡]	PCNI
	5.0 V		TPS76950DBVT [†]	TPS76950DBVR [‡]	PCOI

[†] The DBVT indicates tape and reel of 250 parts.

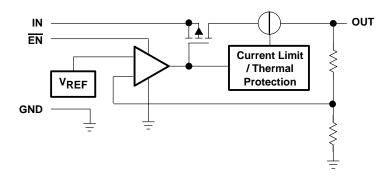
[‡] The DBVR indicates tape and reel of 3000 parts.

functional block diagram

TPS76901



TPS76912/15/18/25/27/28/30/33/50





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Terminal Functions

TERMIN	TERMINAL I/O		DESCRIPTION							
NAME	NO.	1/0	DESCRIPTION							
GND	2		Ground							
EN	3	Ι	Enable input							
FB	4	Ι	Feedback voltage (TPS76901 only)							
IN	1	Ι	Input supply voltage							
NC	4		No connection (Fixed options only)							
OUT	5	0	Regulated output voltage							

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Input voltage range (see Note 1)	–0.3 V to 13.5 V
Voltage range at EN	–0.3 V to V _I + 0.3 V
Voltage on OUT, FB	
Peak output current	Internally limited
ESD rating, HBM	2 kV
Continuous total power dissipation	See Dissipation Rating Table
Operating virtual junction temperature range, T _J	40°C to 150°C
Storage temperature range, T _{stg}	65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to network ground terminal.

DISSIPATION RATING TABLE

BOARD	PACKAGE	$R_{\theta JC}$	$R_{\theta JA}$	DERATING FACTOR ABOVE T _A = 25°C	T _A ≤ 25°C POWER RATING	T _A = 70°C POWER RATING	T _A = 85°C POWER RATING
Low K‡	DBV	65.8 °C/W	259 °C/W	3.9 mW/°C	386 mW	212 mW	154 mW
High K§	DBV	65.8 °C/W	180 °C/W	5.6 mW/°C	555 mW	305 mW	222 mW

[‡] The JEDEC Low K (1s) board design used to derive this data was a 3 inch x 3 inch, two layer board with 2 ounce copper traces on top of the board.
§ The JEDEC High K (2s2p) board design used to derive this data was a 3 inch x 3 inch, multilayer board with 1 ounce internal power and ground planes and 2 ounce copper traces on top and bottom of the board.

recommended operating conditions

	MIN	NOM MAX	UNIT
Input voltage, VI (see Note 2)	2.7	10	V
Output voltage range, VO	1.2	5.5	V
Continuous output current, IO (see Note 3)	0	100	mA
Operating junction temperature, TJ	-40	125	°C

NOTES: 2. To calculate the minimum input voltage for your maximum output current, use the following formula:

 $V_{I}(min) = V_{O}(max) + V_{DO}(max load)$

3. Continuous output current and operating junction temperature are limited by internal protection circuitry, but it is not recommended that the device operate under conditions beyond those specified in this table for extended periods of time.



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electrical characteristics over recommended operating free-air temperature range, $V_I = V_{O(typ)} + 1 V$, $I_O = 100 \text{ mA}$, EN = 0 V, $C_o = 4.7 \mu F$ (unless otherwise noted)

PARAMETER		TEST CO	NDITIONS	MIN	TYP	MAX	UNIT	
	TD070004	$1.2 \text{ V} \le \text{V}_{O} \le 5.5 \text{ V},$	T _J = 25°C		Vo			
	TPS76901	$1.2 \text{ V} \le \text{V}_{O} \le 5.5 \text{ V},$	$T_J = -40^{\circ}C$ to $125^{\circ}C$	0.97V _O		1.03VO		
	TPS76912	T _J = 25°C,	2.7 V < V _{IN} < 10 V		1.224			
	1F370912	$T_{J} = -40^{\circ}C$ to $125^{\circ}C$,	2.7 V < V _{IN} < 10 V	1.187		1.261		
	TPS76915	$T_J = 25^{\circ}C$,	2.7 V < V _{IN} < 10 V		1.5			
	11 37 09 13	$T_J = -40^{\circ}C$ to $125^{\circ}C$,		1.455		1.545		
	TPS76918	$T_J = 25^{\circ}C$,	2.8 V < V _{IN} < 10 V		1.8			
	11 37 0 9 10	$T_J = -40^{\circ}C$ to $125^{\circ}C$,	2.8 V < V _{IN} < 10 V	1.746		1.854		
	TPS76925	$T_J = 25^{\circ}C$,	3.5 V < V _{IN} < 10 V		2.5			
Output voltage (10 μA to 100 mA	11 37 0 9 2 3	$T_J = -40^{\circ}C$ to $125^{\circ}C$,	3.5 V < V _{IN} < 10 V	2.425		2.575	v	
load) (see Note 4)	TPS76927	$T_J = 25^{\circ}C$,	3.7 V < V _{IN} < 10 V		2.7		v	
	11 37 0 9 2 7	$T_{J} = -40^{\circ}C$ to 125°C,	3.7 V < V _{IN} < 10 V	2.619		2.781		
	TPS76928	T _J = 25°C,	3.8 V < V _{IN} < 10 V		2.8			
	1F370920	$T_{J} = -40^{\circ}C$ to 125°C,	3.8 V < V _{IN} < 10 V	2.716		2.884		
	TPS76930	T _J = 25°C,	4.0 V < V _{IN} < 10 V		3.0			
	1P376930	$T_{J} = -40^{\circ}C$ to $125^{\circ}C$,	$4.0 \text{ V} < \text{V}_{IN} < 10 \text{ V}$	2.910		3.090		
	TPS76933	T _J = 25°C,	4.3 V < V _{IN} < 10 V		3.3			
	11 37 0933	$T_{J} = -40^{\circ}C$ to 125°C,	4.3 V < V _{IN} < 10 V	3.201		3.399		
	TD070050	T _J = 25°C,	6.0 V < V _{IN} < 10 V		5.0			
	TPS76950	$T_{J} = -40^{\circ}C$ to 125°C,	6.0 V < V _{IN} < 10 V	4.850		5.150		
Quiescent current (GND current)		EN = 0V, T _J = 25°C	0 mA < I _O < 100 mA,		17		۵	
see Notes 4 and 5)		EN = 0V, T _J = -40°C to 125°C	I _O = 100 mA,			28	μA	
Load regulation		EN = 0V, Т _Ј = 25°С	I _O = 0 to 100 mA,		12		mV	
		V_{O} + 1 V < $V_{I} \le$ 10 V, See Note 4	$T_J = 25^{\circ}C$,		0.04		04.04	
Dutput voltage line regulation ($\Delta V_O/$	vO) (see Note 5)	$V_{O} + 1 V < V_{I} \le 10 V,$ $T_{J} = -40^{\circ}C \text{ to } 125^{\circ}C,$	See Note 4			0.1	%/V 1	
Output noise voltage		BW = 300 Hz to 50 kH $C_0 = 10 \ \mu$ F,	z, TJ = 25°C		190	μV		
Dutput current limit		V _{O =} 0 V,	See Note 4		350	750	mA	
		EN = VI,	2.7 < V _I < 10 V		1		μA	
Standby current		T _J = -40°C to 125°C				2	μA	

NOTES: 4. Minimum IN operating voltage is 2.7 V or V_{O(typ)} + 1 V, whichever is greater. Maximum IN voltage 10 V, minimum output current 10 μA, maximum output current 100 mA.

5. If $V_0 \le 1.8$ V then $V_{Imin} = 2.7$ V, $V_{Imax} = 10$ V:

Line Reg. (mV) =
$$(\%/V) \times \frac{V_O(V_{Imax} - 2.7 V)}{100} \times 1000$$

If $V_O \ge 2.5$ V then $V_{Imin} = V_O + 1$ V, $V_{Imax} = 10$ V:

Line Reg. (mV) =
$$(\%/V) \times \frac{V_O(V_{Imax} - (V_O + 1 V))}{100} \times 1000$$



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electrical characteristics over recommended operating free-air temperature range, $V_I = V_{O(typ)} + 1 V$, $I_O = 100 \text{ mA}$, $\overline{EN} = 0 V$, $C_O = 4.7 \mu F$ (unless otherwise noted) (continued)

PARAMETER		TE	ST CONDITIONS	MIN	TYP	MAX	UNIT			
FB input current		FB = 1.224 V (TP	FB = 1.224 V (TPS76901)				μA			
High level enable input voltage		2.7 V < V _I < 10 V		1.7			V			
Low level enable input voltage		2.7 V < V _I < 10 V				0.9	V			
Power supply ripple rejection		f = 1 kHz, T _J = 25°C,	$C_0 = 10 \ \mu$ F, See Note 4		60		dB			
Input current (EN)		<u>EN</u> = 0 V		-1	0	1	μA			
		EN = VI		-1		1	μA			
		I _O = 50 mA,	T _J = 25°C		60					
	TPS76928	IO = 50 mA,	T _J = -40°C to 125°C			125	125			
	1P570920	I _O = 100 mA,	T _J = 25°C		122					
		I _O = 100 mA,	T _J = −40°C to 125°C			245				
		IO = 50 mA,	T _J = 25°C		57					
	TPS76930	IO = 50 mA,	T _J = −40°C to 125°C			115				
	1P370930	l _O = 100 mA,	T _J = 25°C		115		7			
Dropout voltage (see Note 6)		I _O = 100 mA,	$T_{J} = -40^{\circ}C \text{ to } 125^{\circ}C$			230	mV			
Diopoul voltage (see Note 6)		I _O = 50 mA,	T _J = 25°C		48		IIIV			
	TPS76933	I _O = 50 mA,	$T_{J} = -40^{\circ}C \text{ to } 125^{\circ}C$			100				
	1P370933	I _O = 100 mA,	T _J = 25°C		98					
		I _O = 100 mA,	$T_{J} = -40^{\circ}C \text{ to } 125^{\circ}C$			200				
		IO = 50 mA,	T _J = 25°C		35					
	TPS76950	I _O = 50 mA,	TJ = −40°C to 125°C			85				
	11-370950	I _O = 100 mA,	T _J = 25°C		71					
		I _O = 100 mA,	$T_{J} = -40^{\circ}C \text{ to } 125^{\circ}C$			170				

NOTES: 4. Minimum IN operating voltage is 2.7 V or VO(typ) + 1 V, whichever is greater. Maximum IN voltage 10 V, minimum output current 10 μA, maximum output current 100 mA.

IN voltage equals V_O(Typ) – 100mV; TPS76901 output voltage set to 3.3V nominal with external resistor divider. TPS76912, TPS76915, TPS76918, TPS76925, and TPS76927 dropout voltage limited by input voltage range limitations.

TYPICAL CHARACTERISTICS

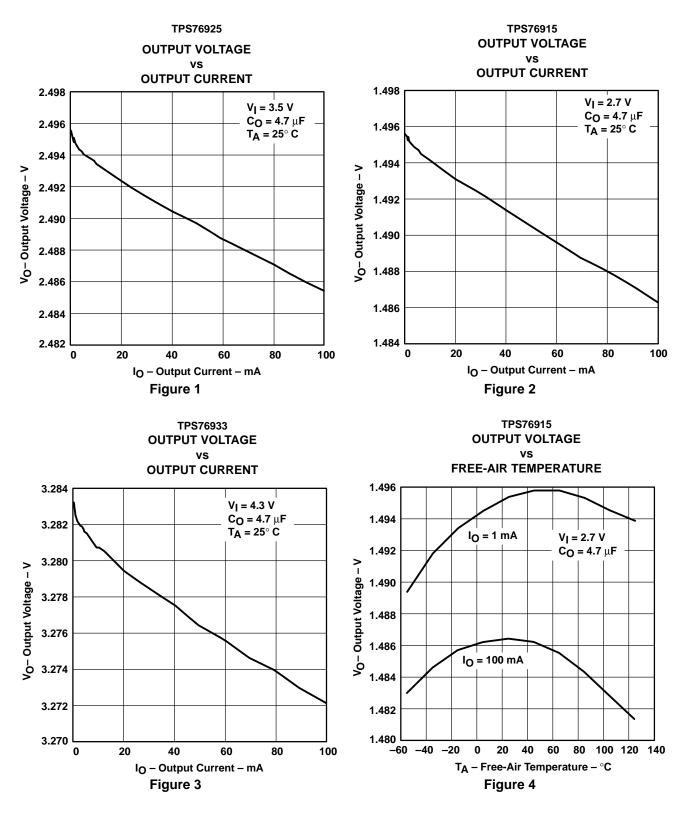
Table of Graphs

			FIGURE
Ve	Output voltage	vs Output current	1, 2, 3
VO	Output voltage	vs Free-air temperature	4, 5, 6
	Ground current	vs Free-air temperature	7
	Output spectral noise density	vs Frequency	8
Z ₀	Output impedance	vs Frequency	9
VDO	Dropout voltage Ripple rejection	vs Free-air temperature	10
		vs Frequency	11
	LDO startup time		12
	Line transient response		13, 15
	Load transient response		14, 16
		vs Output current	17, 19
	Equivalent series resistance (ESR)	vs Added ceramic capacitance	18, 20



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TYPICAL CHARACTERISTICS





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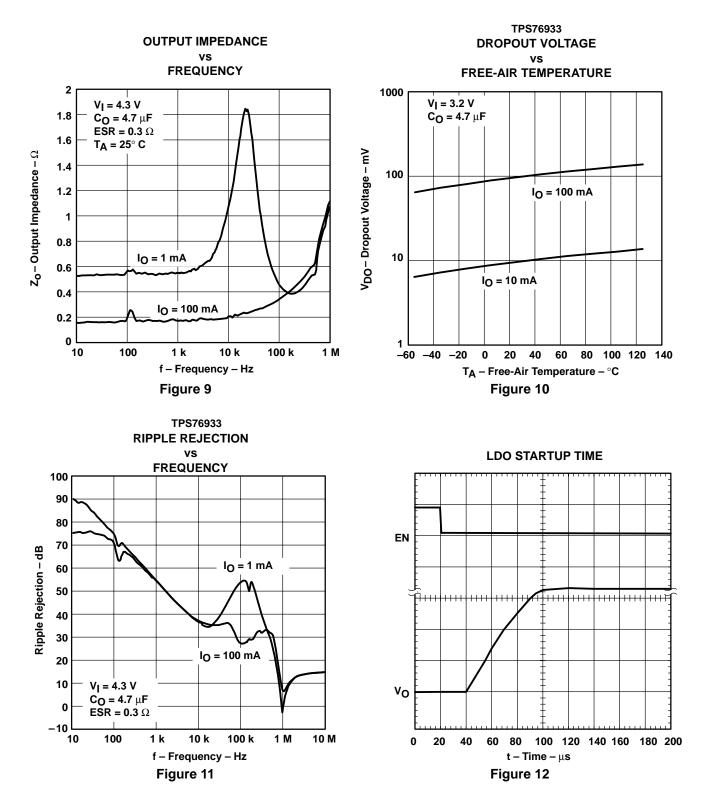
TPS76925 TPS76933 OUTPUT VOLTAGE OUTPUT VOLTAGE vs vs FREE-AIR TEMPERATURE FREE-AIR TEMPERATURE 2.496 3.285 2.494 I_O = 1 mA $I_0 = 1 \text{ mA}$ 3.280 2.492 2.490 2.488 2.486 2.486 2.484 2.484 2.482 V_I = 4.3 V V_O- Output Voltage - V 3.275 $C_0 = 4.7 \ \mu F$ 3.270 I_O = 100 mA I_O = 100 mA 3.265 2.480 $V_{I} = 3.5 V$ 3.260 Co = 4.7 μF 2.478 2.476 3.255 -60 -40 -20 -60 -40 -20 0 20 40 60 80 100 120 140 0 20 40 60 80 100 120 140 T_A – Free-Air Temperature – °C T_A – Free-Air Temperature – °C Figure 5 Figure 6 **TPS76933 TPS76933 GROUND CURRENT OUTPUT SPECTRAL NOISE DENSITY** vs vs FREE-AIR TEMPERATURE FREQUENCY 22 2 VI = 4.3 V Output Spectral Noise Density – $\mu V \sqrt{Hz}$ 1.8 C_O = 4.7 μF 21 $C_0 = 10 \ \mu F$ 1.6 $I_0 = 1 \text{ mA}$ $C_0 = 4.7 \ \mu F$ 20 1.4 $I_0 = 100 \text{ mA}$ Ground Current – μ A $I_0 = 100 \text{ mA}$ 1.2 19 1 18 0.8 $I_0 = 0 mA$ **C**_O = 4.7 μF I_O = 1 mA 0.6 17 0.4 16 0.2 C_O = 10 μF V_I = 4.3 V $I_0 = 100 \text{ mA}$ ||15 0 -60 -40 -20 40 0 20 60 80 100 120 140 100 100k 1k 10k T_A – Free-Air Temperature – °C f - Frequency - Hz Figure 7 Figure 8

TYPICAL CHARACTERISTICS



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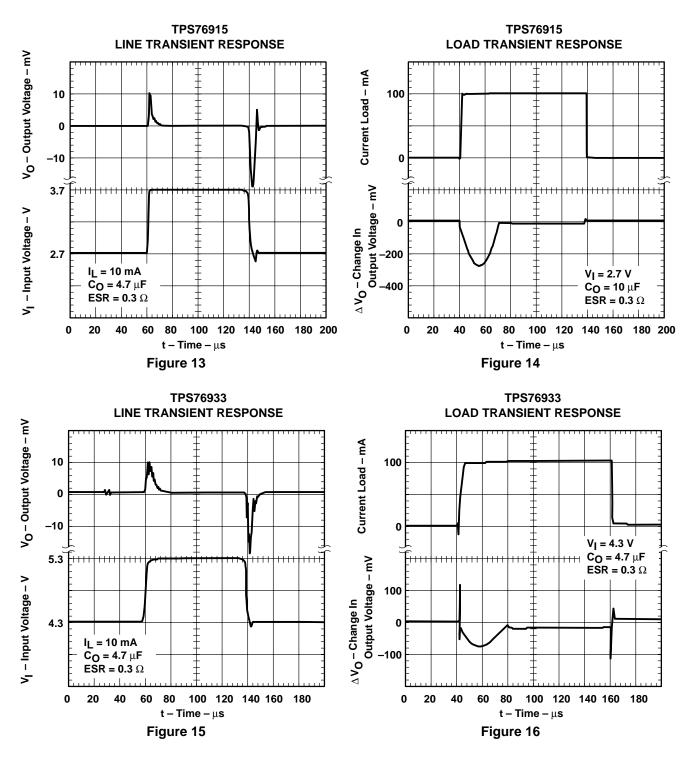
TYPICAL CHARACTERISTICS



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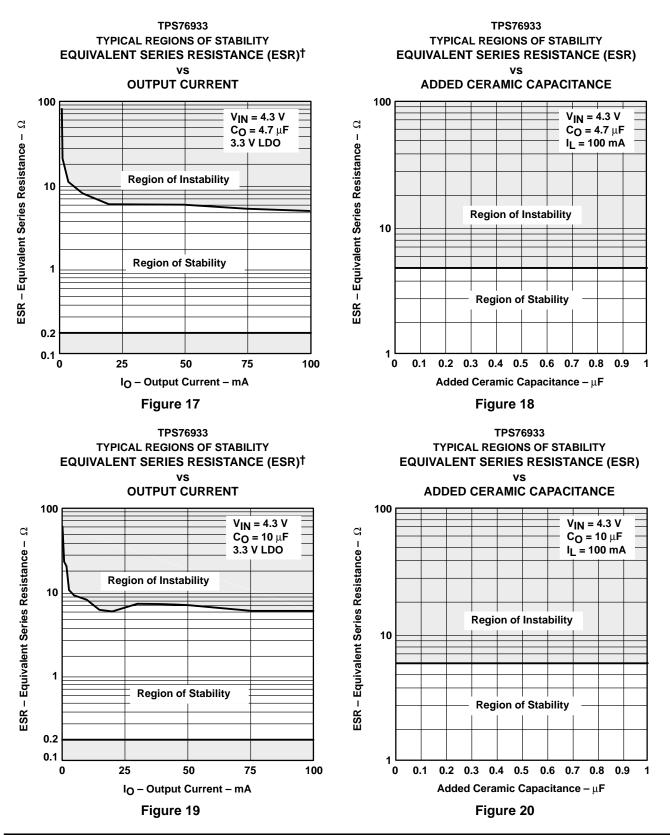
TYPICAL CHARACTERISTICS





TPS76901, TPS76912, TPS76915, TPS76918, TPS76925 TPS76927, TPS76928, TPS76930, TPS76933, TPS76950 ULTRALOW-POWER 100-mA LOW-DROPOUT LINEAR REGULATORS SLVS203E – JUNE 1999 – REVISED MAY 2001

TYPICAL CHARACTERISTICS





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APPLICATION INFORMATION

The TPS769xx family of low-dropout (LDO) regulators have been optimized for use in battery-operated equipment. They feature extremely low dropout voltages, low quiescent current (17 μ A nominally), and enable inputs to reduce supply currents to 1 μ A when the regulators are turned off.

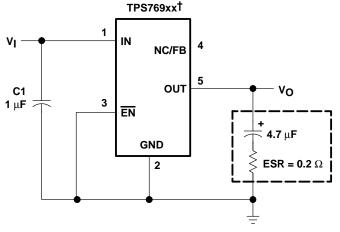
device operation

The TPS769xx uses a PMOS pass element to dramatically reduce both dropout voltage and supply current over more conventional PNP-pass-element LDO designs. The PMOS pass element is a voltage-controlled device and, unlike a PNP transistor, it does not require increased drive current as output current increases. Supply current in the TPS769xx is essentially constant from no load to maximum load.

Current limiting and thermal protection prevent damage by excessive output current and/or power dissipation. The device switches into a constant-current mode at approximately 350 mA; further load reduces the output voltage instead of increasing the output current. The thermal protection shuts the regulator off if the junction temperature rises above approximately 165°C. Recovery is automatic when the junction temperature drops approximately 25°C below the high temperature trip point. The PMOS pass element includes a back gate diode that conducts reverse current when the input voltage level drops below the output voltage level.

A voltage of 1.7 V or greater on the \overline{EN} input will disable the TPS769xx internal circuitry, reducing the supply current to 1µA. A voltage of less than 0.9 V on the \overline{EN} input will enable the TPS769xx and will enable normal operation to resume. The \overline{EN} input does not include any deliberate hysteresis, and it exhibits an actual switching threshold of approximately 1.5 V.

A typical application circuit is shown in Figure 21.



† TPS76912, TPS76915, TPS76918, TPS76925, TPS76927, TPS76928, TPS76930, TPS76933, TPS76950 (fixed-voltage options).

Figure 21. Typical Application Circuit



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APPLICATION INFORMATION

external capacitor requirements

Although not required, a 0.047-µF or larger ceramic input bypass capacitor, connected between IN and GND and located close to the TPS769xx, is recommended to improve transient response and noise rejection. A higher-value electrolytic input capacitor may be necessary if large, fast-rise-time load transients are anticipated and the device is located several inches from the power source.

Like all low dropout regulators, the TPS769xx requires an output capacitor connected between OUT and GND to stabilize the internal control loop. The minimum recommended capacitance is 4.7 µF. The ESR (equivalent series resistance) of the capacitor should be between 0.2 Ω and 10 Ω . to ensure stability. Capacitor values larger than 4.7 μF are acceptable, and allow the use of smaller ESR values. Capacitances less than 4.7 μF are not recommended because they require careful selection of ESR to ensure stability. Solid tantalum electrolytic, aluminum electrolytic, and multilayer ceramic capacitors are all suitable, provided they meet the requirements described above. Most of the commercially available 4.7 µF surface-mount solid tantalum capacitors, including devices from Sprague, Kemet, and Nichico, meet the ESR requirements stated above. Multilayer ceramic capacitors may have very small equivalent series resistances and may thus require the addition of a low value series resistor to ensure stability.

CAPACITOR SELECTION

PART NO.	MFR.	VALUE	MAX ESR [†]	SIZE (H \times L \times W) [†]
T494B475K016AS	KEMET	4.7 μF	1.5 Ω	$1.9\times3.5\times2.8$
195D106x0016x2T	SPRAGUE	10 µF	1.5 Ω	$1.3\times7.0\times2.7$
695D106x003562T	SPRAGUE	10 µF	1.3 Ω	$2.5\times7.6\times2.5$
TPSC475K035R0600	AVX	4.7 μF	0.6 Ω	$2.6\times6.0\times3.2$

[†] Size is in mm. ESR is maximum resistance in Ohms at 100 kHz and T_A = 25°C. Contact manufacturer for minimum ESR values.



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APPLICATION INFORMATION

output voltage programming

The output voltage of the TPS76901 adjustable regulator is programmed using an external resistor divider as shown in Figure 22. The output voltage is calculated using:

$$V_{O} = V_{ref} \times \left(1 + \frac{R1}{R2}\right)$$
(1)

Where:

 $V_{ref} = 1.224 V typ$ (the internal reference voltage)

Resistors R1 and R2 should be chosen for approximately 7- μ A divider current. Lower value resistors can be used but offer no inherent advantage and waste more power. Higher values should be avoided as leakage currents at FB increase the output voltage error. The recommended design procedure is to choose R2 = 169 k Ω to set the divider current at 7 μ A and then calculate R1 using:

$$R1 = \left(\frac{V_{O}}{V_{ref}} - 1\right) \times R2$$
(2)

PROGRAMMING GUIDE DIVIDER RESISTANCE OUTPUT (kΩ)‡ VOLTAGE (V) R1 R2 2.5 174 169 3.3 287 169 3.6 324 169 4.0 383 169 169 5.0 523 [‡]1% values shown.

OUTPUT VOLTAGE

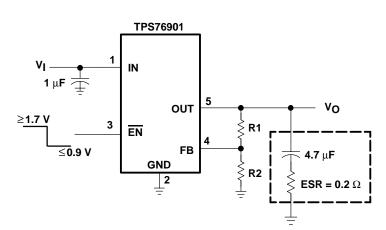


Figure 22. TPS76901 Adjustable LDO Regulator Programming



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APPLICATION INFORMATION

power dissipation and junction temperature

Specified regulator operation is assured to a junction temperature of 125°C; the maximum junction temperature should be restricted to 125°C under normal operating conditions. This restriction limits the power dissipation the regulator can handle in any given application. To ensure the junction temperature is within acceptable limits, calculate the maximum allowable dissipation, PD(max), and the actual dissipation, PD, which must be less than or equal to P_{D(max)}.

The maximum-power-dissipation limit is determined using the following equation:

$$P_{D(max)} = \frac{T_J max - T_A}{R_{\theta JA}}$$

Where:

T_{.1}max is the maximum allowable junction temperature

 $R_{0,IA}$ is the thermal resistance junction-to-ambient for the package, see the dissipation rating table.

T_A is the ambient temperature.

The regulator dissipation is calculated using:

$$\mathsf{P}_{\mathsf{D}} = \left(\mathsf{V}_{\mathsf{I}} - \mathsf{V}_{\mathsf{O}}\right) \times \mathsf{I}_{\mathsf{O}}$$

Power dissipation resulting from quiescent current is negligible. Excessive power dissipation will trigger the thermal protection circuit.

regulator protection

The TPS769xx PMOS-pass transistor has a built-in back diode that conducts reverse current when the input voltage drops below the output voltage (e.g., during power down). Current is conducted from the output to the input and is not internally limited. If extended reverse voltage operation is anticipated, external limiting might be appropriate.

The TPS769xx features internal current limiting and thermal protection. During normal operation, the TPS769xx limits output current to approximately 350 mA. When current limiting engages, the output voltage scales back linearly until the overcurrent condition ends. While current limiting is designed to prevent gross device failure, care should be taken not to exceed the power dissipation ratings of the package. If the temperature of the device exceeds approximately 165°C, thermal-protection circuitry shuts it down. Once the device has cooled down to below approximately 140°C, regulator operation resumes.





24-Jan-2013

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Top-Side Markings	Samples
TPS76901DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCFI	Samples
TPS76901DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCFI	Samples
TPS76901DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCFI	Samples
TPS76901DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCFI	Sample
TPS76912DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCGI	Sample
TPS76912DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCGI	Sample
TPS76912DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCGI	Sample
TPS76912DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCGI	Sample
TPS76915DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		РСНІ	Sample
TPS76915DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		РСНІ	Sample
TPS76915DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCHI	Sample
TPS76915DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCHI	Sample
TPS76918DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCII	Sample
TPS76918DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCII	Sample
TPS76918DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCII	Sample
TPS76918DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCII	Sample
TPS76925DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCJI	Sample



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Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Top-Side Markings	Samples
TPS76925DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCJI	Samples
TPS76925DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCJI	Sample
TPS76925DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCJI	Sample
TPS76927DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCKI	Sample
TPS76927DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCKI	Sample
TPS76927DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCKI	Sample
TPS76927DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCKI	Sample
TPS76928DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCLI	Sample
TPS76928DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCLI	Sample
TPS76928DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCLI	Sample
TPS76928DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCLI	Sample
TPS76930DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCMI	Sample
TPS76930DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCMI	Sample
TPS76930DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCMI	Sample
TPS76930DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCMI	Sample
TPS76933DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCNI	Sample
TPS76933DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCNI	Sample
TPS76933DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCNI	Sample



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Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Top-Side Markings	Samples
TPS76933DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCNI	Samples
TPS76950DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCOI	Samples
TPS76950DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCOI	Samples
TPS76950DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCOI	Samples
TPS76950DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		PCOI	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ Only one of markings shown within the brackets will appear on the physical device.

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OTHER QUALIFIED VERSIONS OF TPS76901, TPS76912, TPS76915, TPS76918, TPS76925, TPS76927, TPS76928, TPS76930, TPS76933, TPS76950 :

• Automotive: TPS76901-Q1, TPS76912-Q1, TPS76915-Q1, TPS76918-Q1, TPS76925-Q1, TPS76927-Q1, TPS76928-Q1, TPS76930-Q1, TPS76933-Q1, TPS76950-Q1

• Enhanced Product: TPS76901-EP

NOTE: Qualified Version Definitions:

- Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Enhanced Product Supports Defense, Aerospace and Medical Applications

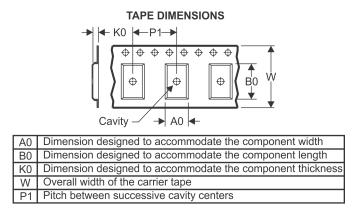
PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS76901DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS76901DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS76912DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS76912DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS76915DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS76915DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS76918DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS76918DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS76925DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS76925DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS76927DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS76927DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS76928DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS76928DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS76930DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS76930DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS76933DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS76933DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3

PACKAGE MATERIALS INFORMATION

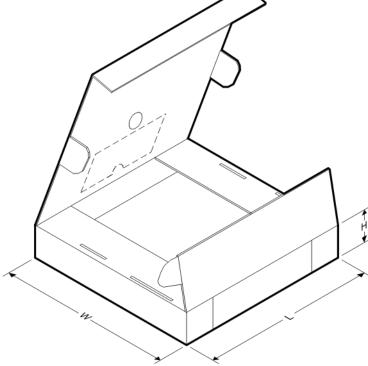


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Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS76950DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS76950DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3





*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS76901DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS76901DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS76912DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS76912DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS76915DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS76915DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS76918DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS76918DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS76925DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS76925DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS76927DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS76927DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS76928DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS76928DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS76930DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0

PACKAGE MATERIALS INFORMATION



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8-May-2013

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS76930DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS76933DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS76933DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS76950DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS76950DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0

DBV (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
 - This drawing is subject to change without notice. Β.
 - Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side. C.
 - D. Falls within JEDEC MO-178 Variation AA.



DBV (R-PDSO-G5)

PLASTIC SMALL OUTLINE



NOTES:

A. All linear dimensions are in millimeters.B. This drawing is subject to change without notice.

- C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
- D. Publication IPC-7351 is recommended for alternate designs.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.



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